# imall

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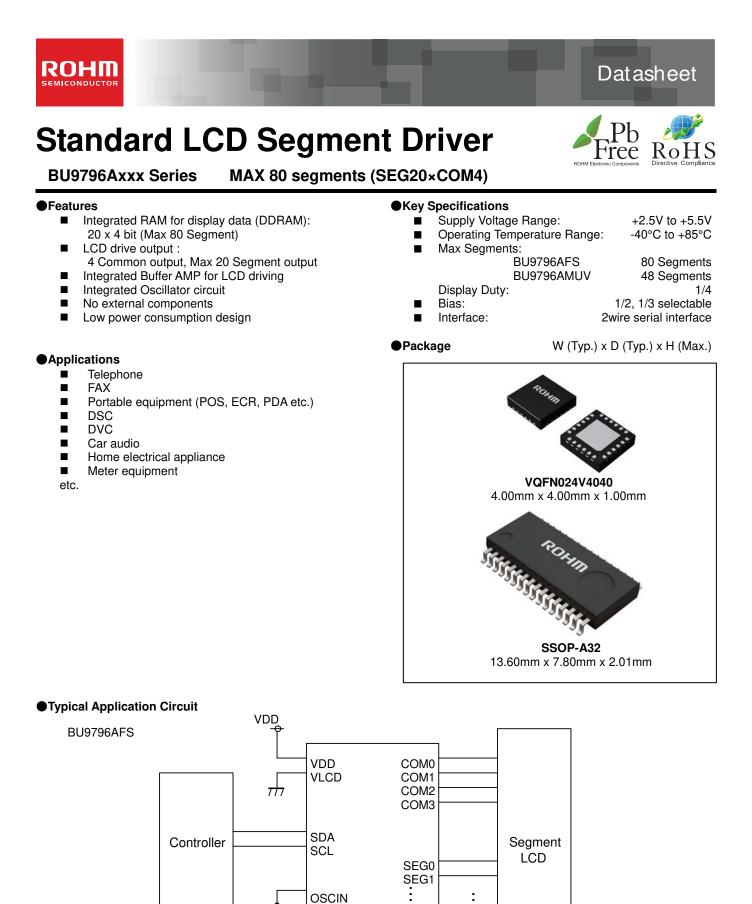
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TEST1 TEST2 VSS

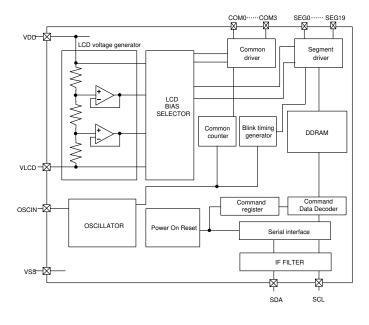
Using internal oscillator Figure 1. Typical application circuit

i

SEG19

# Block Diagram / Pin Configuration / Pin Description

# BU9796AFS



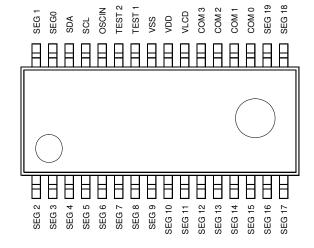


Figure 2. Block Diagram

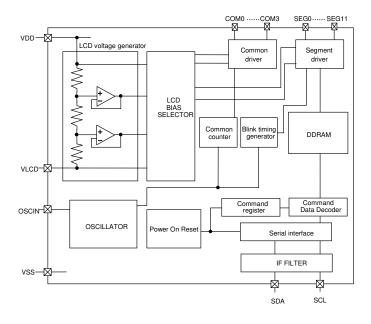
# Figure 3. Pin Configuration (TOP VIEW)

Table	1	Pin	Description

Terminal	Terminal No.	I/O	Function
TEST1	26	I	Test input (ROHM use only) Must be connect to VSS
TEST2	27	Ι	Test input (ROHM use only) TEST2="L": POR circuit enable TEST2="H": POR circuit disenable, refer to "Cautions in Power ON/OFF"
OSCIN	28	Ι	External clock input External clock and Internal clock can be selected by command. Must be connect to VSS when use internal oscillation circuit.
SDA	30	I/O	serial data in-out terminal
SCL	29	Ι	serial data transfer clock
VSS	25		GND
VDD	24		Power supply
VLCD	23		Power supply for LCD driving
SEG0-19	31,32 1-18	0	SEGMENT output for LCD driving
COM0-3	19-22	0	COMMON output for LCD driving

# Block Diagram / Pin Configuration / Pin Description- continued

# BU9796AMUV



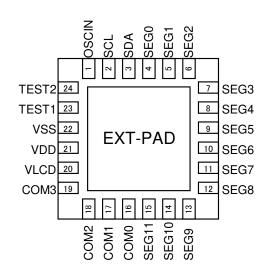


Figure 4. Block Diagram



t	<del>.</del>		
Terminal	Terminal No.	I/O	Function
TEST1	23	I	Test input (ROHM use only) Must be connect to VSS
TEST2	24	Ι	Test input (ROHM use only) TEST2="L": POR circuit enable TEST2="H": POR circuit disenable, refer to "Cautions in Power ON/OFF"
OSCIN	1	Ι	External clock input External clock and Internal clock can be selected by command. Must be connect to VSS when use internal oscillation circuit.
SDA	3	I/O	serial data in-out terminal
SCL	2	Ι	serial data transfer clock
VSS	22		GND
VDD	21		Power supply
VLCD	20		Power supply for LCD driving
SEG0-11	4-15	0	SEGMENT output for LCD driving
COM0-3	16-19	0	COMMON output for LCD driving
EXT-PAD	-(*1)	-	Substrate

\*1: To radiate heat, please contact a board with the EXT-PAD which is located at the bottom side of VQFN024V4044 package.

Please supply VSS level or Open state as the input condition for this PAD.

# Absolute Maximum Ratings (VSS=0V)

Parameter	Symbol	Ratings	Unit	Remarks
Power Supply Voltage1	VDD	-0.5 to +7.0	V	Power supply
Power Supply Voltage2	VLCD	-0.5 to VDD	V	LCD drive voltage
Allowable loss	Pd	0.64	W	When use more than Ta=25°C, subtract 6.4mW per degree. (BU9796AFS) (Package only)
Allowable loss	FU	0.27	W	When use more than Ta=25°C, subtract 2.7mW per degree. (BU9796AMUV) (Package only)
Input voltage range	VIN	-0.5 to VDD+0.5	V	
Operational temperature range	Topr	-40 to +85	°C	
Storage temperature range	Tstg	-55 to +125	°C	

# Recommended Operating Ratings (Ta=-40°C to +85°C,VSS=0V)

Parameter	Symbol		Ratings		Unit	Remarks						
Farameter	Symbol	MIN	TYP	MAX	Unit	nenialis						
Power Supply Voltage1	VDD	2.5	-	5.5	V	Power supply						
Power Supply Voltage2	VLCD	0	-	VDD-2.4	V	LCD drive voltage						

# •Electrical Characteristics

DC Characteristics (VDD=2.5V to 5.5V, VLCD=0V, VSS=0V, Ta=-40°C to 85°C, unless otherwise specified)

Param	Parameter			Limits		Unit	Conditions				
Falalli	elei	Symbol	MIN	MIN TYP		Unit	Conditions				
"H" level input vol	VIH	0.7VDD	-	VDD	V	SDA,SCL					
"L" level input voli	VIL	VSS	-	0.3VDD	V	SDA,SCL					
"H" level input cur	IIH	-	-	1	μA	SDA,SCL					
"L" level input cur	IIL	-1	-	-	μA	SDA,SCL					
LCD Driver on	SEG	RON	-	3	-	kΩ	lload=±10µA				
resistance	COM	RON	-	3	-	kΩ	lioau=±τομΑ				
VLCD supply volta	age	VLCD	0	-	VDD-2.4	V	VDD-VLCD≥2.4V				
Standby current		IDD1	-	-	5	μA	Display off, Oscillation off				
Power consumpti	IDD2	-	12.5	30	μA	VDD=3.3V, VLCD=0V, Ta=25°C Power save mode1, FR=71Hz 1/3 bias, Frame inverse					

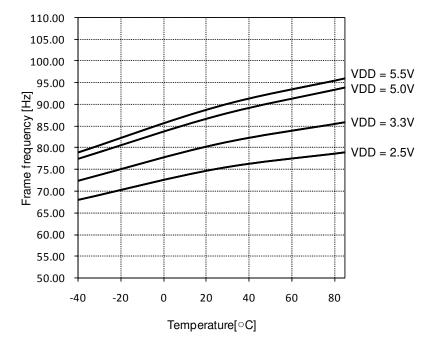
Oscillation Characteristics (VDD=2.5V to 5.5V, VLCD=0V, VSS=0V, Ta=-40°C to 85°C, unless otherwise specified)

Parameter	Symbol		Limits		Unit	Conditions
Faidmeter	Symbol	MIN	TYP	MAX	Unit	Conditions
Frame frequency	fCLK	56	80	104	Hz	FR = 80Hz setting, VDD=3.3V Internal OSC is used.
External frequency	fEXCLK	15	-	300	KHz	External clock is used. (*1)

(\*1) <Frame frequency Calculation at external clock mode>

DISCTL 80Hz setting :Frame frequency [Hz] = external clock [Hz] / 512DISCTL 71Hz setting :Frame frequency [Hz] = external clock [Hz] / 576DISCTL 64Hz setting :Frame frequency [Hz] = external clock [Hz] / 648DISCTL 53Hz setting :Frame frequency [Hz] = external clock [Hz] / 768

# [Reference Data]



Typical temperature characteristics

# Electrical Characteristics - continued

MPU interface Characteristics (VDD=2.5V to 5.5V, VLCD=0V, VSS=0V, Ta=-40°C to 85°C, unless otherwise specified)

Parameter	Cumbal		Limits		Unit	Conditions				
Parameter	Symbol	MIN	MIN TYP		Unit	Conditions				
Input rise time	tr	-	-	0.3	μs					
Input fall time	tf	-	-	0.3	μs					
SCL cycle time	tSCYC	2.5	-	-	μs					
"H" SCL pulse width	tSHW	0.6	-	-	μs					
"L" SCL pulse width	tSLW	1.3	-	-	μs					
SDA setup time	tSDS	100	-	-	μs					
SDA hold time	tSDH	100	-	-	us					
Buss free time	tBUF	1.3	-	-	μs					
START condition hold time	tHD;STA	0.6	-	-	μs					
START condition setup time	tSU;STA	0.6	-	-	μs					
STOP condition setup time	tSU;STO	0.6	-	-	μs					

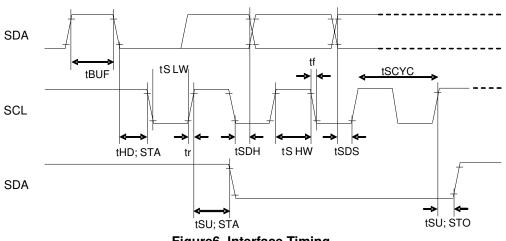
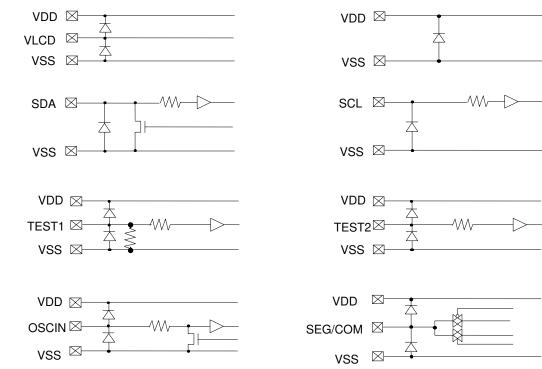


Figure6. Interface Timing

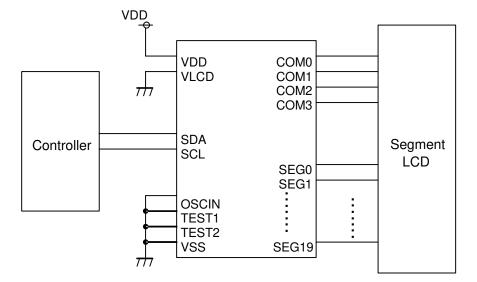
# ●I/O equivalent circuit



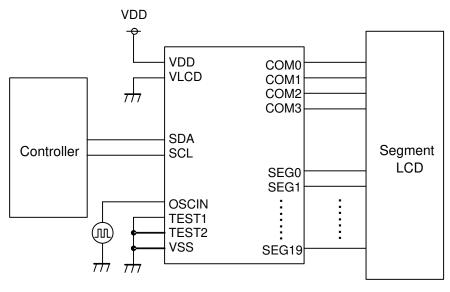
# Figure7. I/O equivalent circuit

# •Example of recommended circuit

# <BU9796AFS>



Internal Oscillator circuit use mode

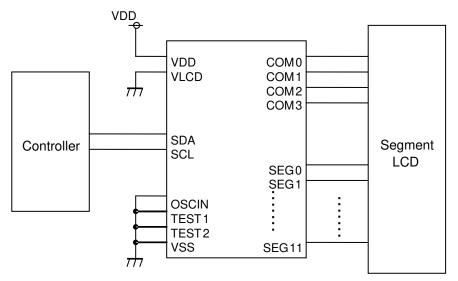


External clock input mode

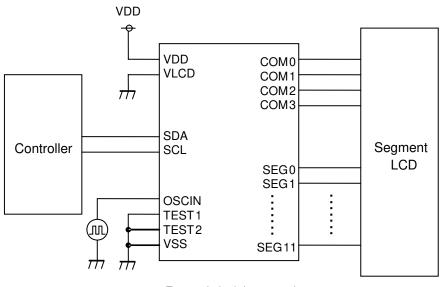
Figure8. Example of recommended circuit

# Example of recommended circuit - continued

# <BU9796AMUV>



Internal Oscillator circuit use mode



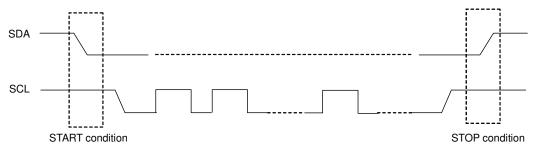
External clock input mode

Figure 9. Example of recommended circuit

# •Functional descriptions

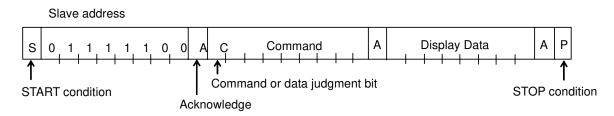
OCommand /Data transfer method

This device is controlled by 2wire signal (SDA, SCL).





It has to generate the condition such as START condition and STOP condition in 2wire serial interface transfer method.



# Figure11. Interface protcol

Method of how to transfer command and data is shown as follows.

- 1) Generate "START condition".
- 2) Issue Slave address.
- 3) Transfer command and display data.

OAcknowledge

Data format is 8bits and return Acknowledge after transfer 8bits data.

When SCL 8th='L' after transfer 8bit data (Slave Address, Command, Display Data), output 'L' and open SDA line. When SCL 9th='L', stop output function.

(As Output format is NMOS-Open-Drain, can't output 'H' level.)

If no need Acknowledge function, please input 'L' level from SCL 8th='L' to SCL 9th='L'.

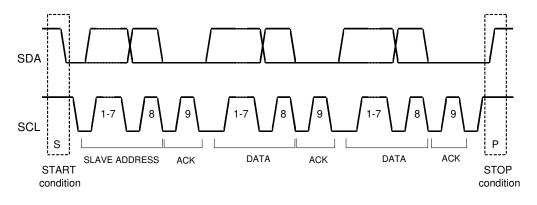


Figure 12. Acknowledge timing

# OCommand transfer method

Issue Slave Address ("01111100") after generate "START condition". 1byte after Slave Address always becomes command input. MSB ("command or data judge bit") of command decide to next data is command or display data. When set "command or data judge bit"='1', next byte will be command. When set "command or data judge bit"='0', next byte data is display data.

S Slave address A 1 Command A 1 Command A 1 Com
---

Once it becomes display data transfer condition, it cannot input command.

When want to input command again, please generate "START condition" once.

If "START condition" or "STOP condition" are inputted in the middle of command transmission, command will be canceled.

If Slave address is continuously inputted following "START condition", it will be in command input condition.

Please input "Slave Address" in the first data transmission after "START condition".

When Slave Address cannot be recognized in the first data transmission, Acknowledge does not return and next transmission will be invalid. When data transmission is in invalid status, if "START conditions" are transmitted again, it will return to valid status.

Please consider the MPU interface characteristic such as Input rise time and Setup/Hold time when transferring command and data (Refer to MPU Interface).

#### OWrite display and transfer method

#### <BU9796AFS>

This device has Display Data RAM (DDRAM) of 20×4=80bit.

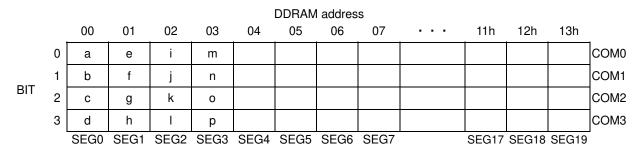
The relationship between data input and display data, DDRAM data and address are as follows;

	Slave address			Command																				
s	01111100	А	0	0000000	A	a	b	с	d	е	f	g	h	А	i	j	k	I	m	n	0	р	A	 Р
•							Di:	ı spla	ıy D	ata	l	1	1	•			1		I		1	1	•	•

8 bit data will be stored in DDRAM. The address to be written is the address specified by ADSET command, and the address is automatically incremented in every 4bit data.

Data can be continuously written in DDRAM by transmitting Data continuously.

(When RAM data is written successively after writing RAM data to 13h (SEG19), the address is returned to 00h (SEG0) by the auto-increment function.



Data transfer to DDRAM happens every 4bit data. So it will be finished to transfer with no need to wait ACK.

#### <BU9796AMUV>

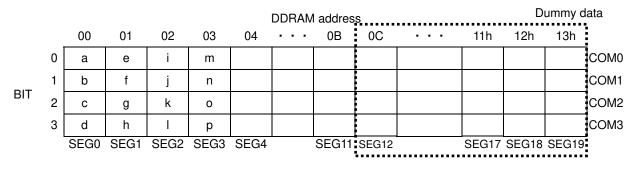
This device has Display Data RAM (DDRAM) of 12×4=48bit. The relationship between data input and display data, DDRAM data and address are as follows; ، ام ام

	Slave address	_		Command																				 
s	01111100	A	0	0000000	А	a	b	с	d	е	f	g	h	А	i	j	k	I	m	n	0	р	A	 Р
							∎ Di:	spla	ı ıy D	ata	l	1	1			1	I	T	I	I	I	Ţ		

8 bit data will be stored in DDRAM. The address to be written is the address specified by ADSET command, and the address is automatically incremented in every 4bit data.

Data can be continuously written in DDRAM by transmitting Data continuously.

(When RAM data is written successively after writing RAM data to 13h (SEG19), the address is returned to 00h (SEG0) by the auto-increment function.

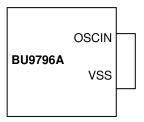


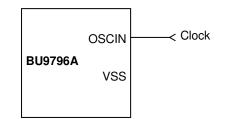
Data transfer to DDRAM happens every 4bit data. So it will be finished to transfer with no need to wait ACK.

# OOSCILLATOR

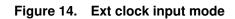
The clock signals for logic and analog circuit can be generated from internal oscillator or external clock. If internal oscillator circuit is used, OSCIN must be connected to VSS level.

\*When using external clock mode, input external clock from OSCIN terminal after ICSET command setting.





# Figure 13. Internal oscillator circuit mode



O LCD Driver Bias Circuit

This device generates LCD driving voltage with on-chip Buffer AMP. And it can drive LCD at low power consumption. \*1/3 and 1/2Bias can set in MODESET command. \*Line and frame inversion can set in DISCTL command. Refer to the "LCD driving waveform" about each LCD driving waveform.

# O Blink timing generator

This device has Blink function.

This device will be Blink mode with BLKCTL command.

Blink frequency varies widely by characteristic of fCLK, when internal oscillation circuit. About the characteristics of fCLK, refer to Oscillation Characteristics.

#### O Reset initialize condition

Initial condition after execute Software Reset is as follows.

Display is OFF.

· DDRAM address is initialized (DDRAM Data is not initialized).

Refer to Command Description about initialize value of register.

# Command / Function List

Description List of Command / Function

No.	Command	Function
1	Display Control (DISCTL)	Set LCD display mode 1
2	Mode Set (MODESET)	Set LCD drive mode
3	Address Set (ADSET)	Set LCD display mode 2
4	Set IC Operation (ICSET)	Set IC operation
5	Blink Control (BLKCTL)	Set blink mode
6	All Pixel Control (APCTL)	Set pixel condition

# Detailed command description

D7 (MSB) is bit for command or data judgment. Refer to Command and data transfer method.

- C: 0: Next byte is RAM write data.
  - 1: Next byte is command.

ODisplay control (DISCTL)

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	0	1	P4	P3	P2	P1	P0

Set Power save mode FR

Power save mode FR	P4	P3	Reset initialize condition				
Normal mode (80Hz)	0	0	0				
Power save mode1 (71Hz)	0	1					
Power save mode2 (64Hz)	1	0					
Power save mode3 (50Hz)	1	1					

Power consumption is reduced in the follow order:

Normal mode > Power save mode1 > Power save mode2 > Power save mode3

#### Set LCD drive waveform

Setup	P2	Reset initialize condition
Line inversion	0	0
Frame inversion	1	

\* Power consumption is reduced in the follow order: Line inversion > Frame inversion Refer to LCD drive waveform

#### Set Power save mode SR

Setup	P1	P0	Reset initialize condition				
Power save mode1	0	0					
Power save mode2	0	1					
Normal mode	1	0	0				
High power mode	1	1					

\* Power consumption is increased in the follow order:

Power save mode 1 < Power save mode 2 < Normal mode < High power mode

#### (Reference current consumption data)

Setup	Current consumption
Power save mode 1	×0.5
Power save mode 2	×0.67
Normal mode	×1.0
High power mode	×1.8

\*Above data is reference. It depends on Panel load.

(Note) The setting of Power save mode FR, LCD waveform, Power save mode will influence the following display image qualities. Please select most suitable value from current consumption and display image quality with LCD panel.

Mode	Flicker	Image quality, contrast
Power save mode FR	0	-
LCD waveform	0	0
Power save mode SR	-	0

# OMode Set (MODE SET)

MSB D7	D6	D5	D4	D3	D2	D1	D0
С	1	0	*	P3	P2	*	*

(\*: Don't care)

#### Set display ON and OFF

Setting	P3	Reset initialize condition
Display OFF	0	0
Display ON	1	

Display OFF : Regardless of DDRAM data, all SEGMENT and COMMON output will be stopped after 1frame off data write. Display OFF mode will be disabled after Display ON command.

Display ON : SEGMENT and COMMON output will be active and start to read the display data from DDRAM.

. ....

#### Set bias level

setup	P2	Reset initialize condition				
1/3 Bias	0	0				
1/2 Bias	1					
	,					

Refer to LCD driving waveform

#### OAddress set (ADSET)

MSB		-					LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	0	0	P4	P3	P2	P1	P0

The range of address can be set as 00000 to 10011(2). Don't set out of range address, otherwise address will be set 00000.

# OSet IC Operation (ICSET)

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	1	1	0	1	*	P1	P0

(\*:Don't care)

Set software reset execution

Setup	P1
No operation	0
Software Reset execute	1
<b>T</b> 1 (1) (1) (1) (1) (1) (1) (1) (1) (1) (1	

This command will be set initialize condition.

#### Set oscillator mode

setup	P0	Reset initialize condition
Internal oscillation	0	0
External clock input	1	

Internal oscillation: Must be connected to VSS.

External clock input: Input external clock from OSCIN terminal

#### [Frame frequency Calculation at external clock mode]

DISCTL 80Hz setting:	Frame frequency [Hz] = external clock [Hz] / 512
DISCTL 71Hz setting:	Frame frequency [Hz] = external clock [Hz] / 576
DISCTL 64Hz setting:	Frame frequency [Hz] = external clock [Hz] / 648
DISCTL 53Hz setting:	Frame frequency [Hz] = external clock [Hz] / 768

CommandX ICSET	X	
OSCIN_EN		
(internal) Internal OSC mode		External clock mode
INT oscillation		
(internal)		
EXT clock		
(OSCIN)		

Figure 15. Oscillator mode change timing

# **OBlink control (BLKCTL)**

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	1	1	1	0	*	P1	P0
(* · Don't	aara)						

\* : Don't care)

#### Set blink mode

Blink mode (Hz)	P1	P0	Reset initialize condition
OFF	0	0	0
0.5	0	1	
1	1	0	
2	1	1	

The Blink cycle varies by fclk characteristic when the internal oscillation circuit is used. Refer to the item of oscillation characteristic for the fclk characteristic.

# OAll Pixel control (APCTL)

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
С	1	1	1	1	1	P1	P0

All display set ON, OFF

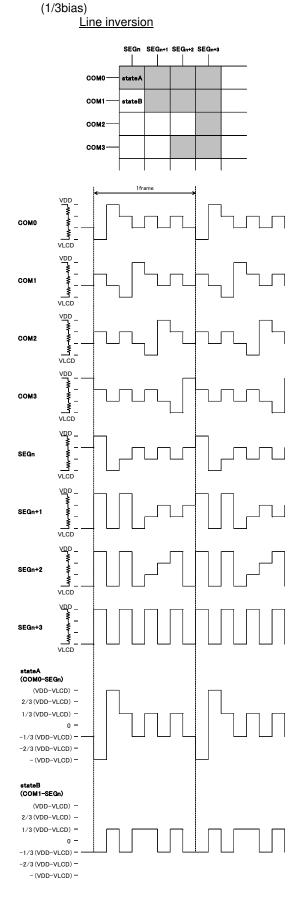
APON	P1	Reset initialize condition
Normal	0	0
All pixel ON	1	

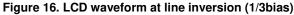
APOFF	P0	Reset initialize condition
Normal	0	0
All pixel OFF	1	

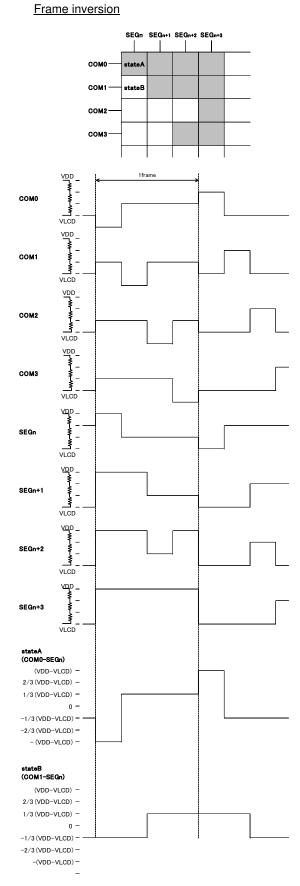
All pixels ON: All pixels are ON regardless of DDRAM data All pixels OFF: All pixels are OFF regardless of DDRAM data

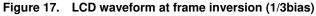
(Note) This command is valid in Display on status. The data of DDRAM don't change by this command. If set both P1 and P0 ="1", APOFF will be select.

# LCD driving waveform

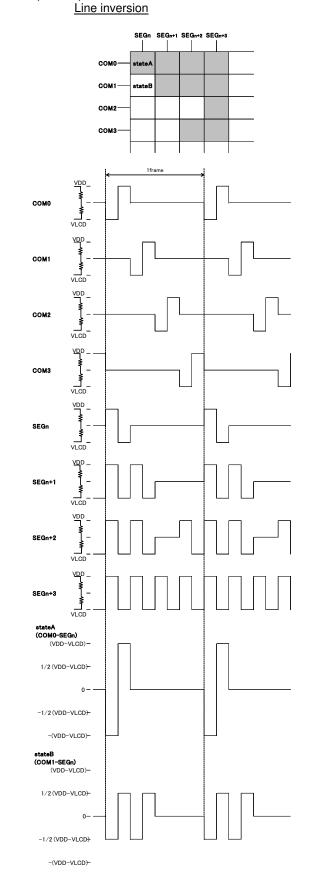








(1/2bias)



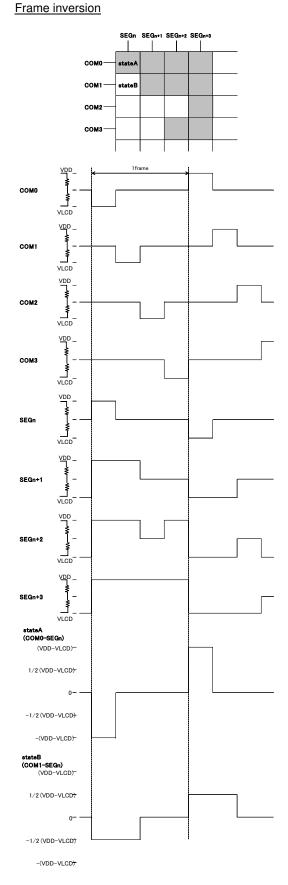
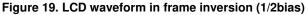


Figure 18. LCD waveform in line inversion (1/2bias)



# •Example of display data

If LCD layout pattern is like as Figure 20, Figure 21, and display pattern is like as Figure . Display data will be shown as follows;

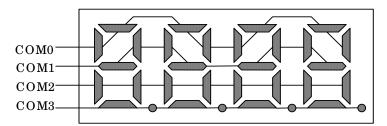


Figure 20. E.g. COM line pattern

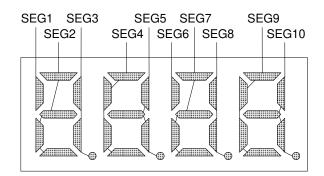


Figure 21. E.g. SEG line pattern

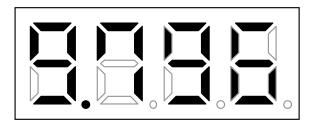


Figure 22. E.g. Display pattern

<DDRAM data mapping in Figure display pattern>

		S E G 0	S E G 1	S E G 2	S E G 3	S E G 4	S E G 5	S E G 6	S E G 7	S E G 8	S E G 9	S E G 10	S E G 11	S E G 12	S E G 13	S E G 14	S E G 15	S E G 16	S E G 17	S E G 18	S E G 19
COM0	D0	0	1	1	0	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0
COM1	D1	0	0	1	1	1	0	0	1	1	1	1	0	0	0	0	0	0	0	0	0
COM2	D2	0	0	0	1	0	1	0	0	1	1	1	0	0	0	0	0	0	0	0	0
COM3	D3	0	0	1	1	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0
Address		00h	01h	02h	03h	04h	05h	06h	07h	08h	09h	0Ah	0Bh	0Ch	0Dh	0Eh	0Fh	10h	11h	12h	13h

# Initialize sequence

Please follow below sequence after Power-on to set this LSI to initial condition.

Power on  $\downarrow$ STOP condition  $\downarrow$ START condition  $\downarrow$ Issue slave address  $\downarrow$ Execute Software Reset by sending ICSET command.

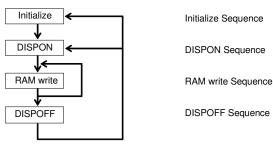
\*Each register value and DDRAM address, DDRAM data are random condition after power on till initialize sequence is executed.

# •Start sequence

OStart sequence example1

No.	Input	D7	D6	D5	D4	D3	D2	D1	D0	Descriptions
1	Power on									VDD=0→5V (Tr=0.1ms)
	$\downarrow$									
2	wait 100µs									Initialize IC
	$\downarrow$									
3	Stop									Stop condition
	↓									
4	Start									Start condition
	$\downarrow$									
5	Slave address	0	1	1	1	1	1	0	0	Issue slave address
	$\downarrow$									
6	ICSET	1	1	1	0	1	*	1	0	Software Reset
	$\downarrow$									
7	BLKCTL	1	1	1	1	0	*	0	1	
	↓									
8	DISCTL	1	0	1	1	1	1	0	0	
	$\downarrow$									
9	ICSET	1	1	1	0	1	*	0	1	
	$\downarrow$									
10	ADSET	0	0	0	0	0	0	0	0	RAM address set
	$\downarrow$									
11	Display Data	*	*	*	*	*	*	*	*	address 00h - 01h
	Display Data	*	*	*	*	*	*	*	*	address 02h - 03h
					*					
	Display Data	*	*	*	*	*	*	*	*	address 12h - 13h
	↓ ~									
12	Stop	_								Stop condition
	→									
13	Start									Start condition
	↓			4				<u>^</u>	<u> </u>	
14	Slave address	0	1	1	1	1	1	0	0	Issue slave address
45		-	4	0	*	4	0	*	*	Display ON
15	MODESET	1	1	0		1	0			Display ON
10	↓ 									Ohan aan dikian
16	Stop									Stop condition

OStart sequence example2



This LSI is initialized with Initialize Sequence. And start to display with DISPON Sequence.

This LSI will update display data with RAM write Sequence. And stop the display with DISPOFF sequence.

If you want to restart to display, This LSI will restart to display with DISPON Sequence.

Initialize sequence

loout				DA	TΑ				Description		
Input	D7	07 D6 I		D4	D3	D2	D1	D0	Description		
Power on											
wait 100us											
STOP											
START											
Slave address	0	1	1	1	1	1	0	0	Execute Software Reset		
ICSET	1	1	1	0	1	0	1	0	Display OFF		
MODESET	1	1	0	0	0	0	0	0	RAM address set		
ADSET	0	0	0	0	0	0	0	0	Display data		
Display data	*	*	*	*	*	*	*	*			
STOP											

#### Dispon sequence

Input				DA	TΑ				Description	
Input	D7	D6	D5	D4	D3	D2	D1	D0	Description	
START										
Slave address	0	1	1	1	1	1	0	0		
ICSET	1	1	1	0	1	0	0	0	Execute internal OSC mode	
DISCTL	1	0	1	1	1	1	1	1	Set Display Control	
BLKCTL	1	1	1	1	0	0	0	0	Set BLKCTL	
APCTL	1	1	1	1	1	1	0	0	Set APCTL	
MODESET	1	1	0	0	1	0	0	0	Display ON	
STOP										

#### RAM write sequence

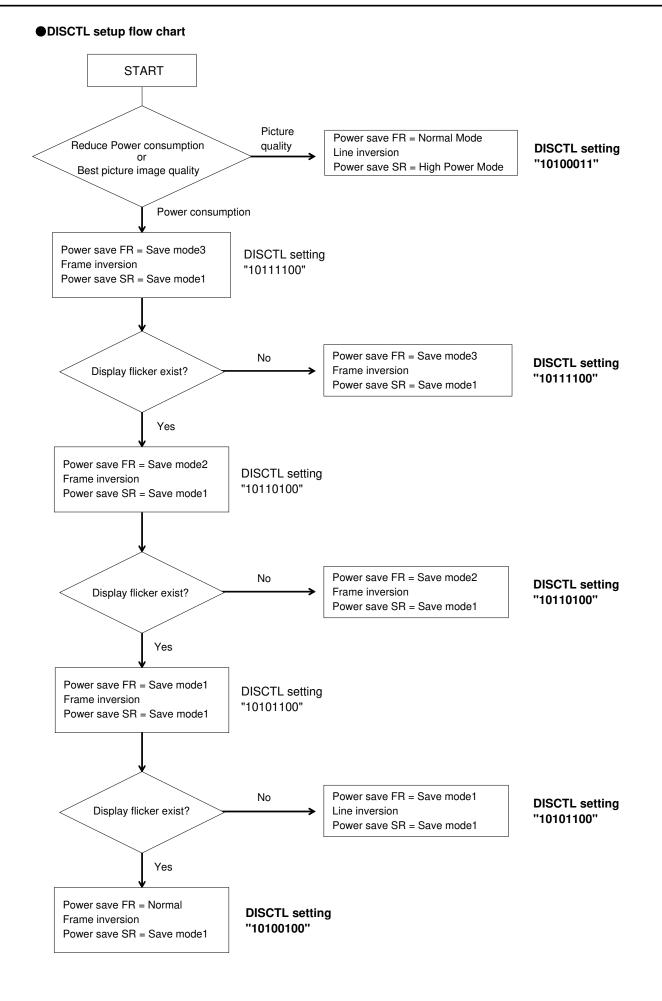
Input				DA	ТА				Description	
Input		D6	D5	D4	D3	D2	D1	D0		
START										
Slave address	0	1	1	1	1	1	0	0		
ICSET	1	1	1	0	1	0	0	0	Execute internal OSC mode	
DISCTL	1	0	1	1	1	1	1	1	Set Display Control	
BLKCTL	1	1	1	1	0	0	0	0	Set BLKCTL	
APCTL	1	1	1	1	1	1	0	0	Set APCTL	
MODESET	1	1	0	0	1	0	0	0	Display ON	
ADSET	0	0	0	0	0	0	0	0	RAM address set	
Display Data	*	*	*	*	*	*	*	*	Display data	
STOP										

# Dispoff sequence

loout				DA	TΑ				Description	
Input		D6	D5	D4	D3	D2	D1	D0	Description	
START										
Slave address	0	1	1	1	1	1	0	0		
ICSET	1	1	1	0	1	0	0	0	Execute internal OSC mode	
MODESET	1	1	0	0	0	0	0	0	Display OFF	
STOP										

Abnormal operation may occur in BU9796A due to the effect of noise or other external factor.

To avoid this phenomenon, please input command according to sequence described above during initialization, display ON/OFF and refresh of RAM data.



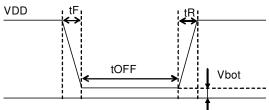
# Cautions in Power ON/OFF

This device has "P.O.R" (Power-On Reset) circuit and Software Reset function. Please keep the following recommended Power-On conditions in order to power up properly.

Please set power up conditions to meet the recommended tR, tF, tOFF, and Vbot spec below in order to ensure P.O.R operation

1ms

'It has to set TEST1="L" to be valid in POR circuit.



Recommended condition of tR, tF, tOFF, Vbot (Ta=25°C								
	tR	tF	tOFF	Vbot				
	Less than	Less than	More than	Less than				

1ms

100ms

0.1V

Figure 23. Power ON/OFF waveform

If it is difficult to meet above conditions, execute the following sequence after Power-On.

- It has to keep the following sequence in the case of TEST2="H". As POR circuit is invalid status. But it is not able to accept Command input in Power off status, it has to take care that software reset is not perfectly alternative method of POR function.
  - (1) Generate STOP condition

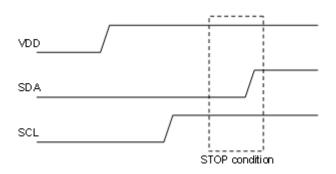


Figure 24. Stop Condition

(2) Generate START condition.

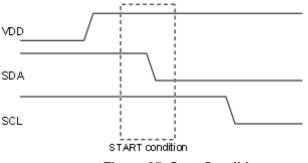


Figure 25. Start Condition

- (3) Issue slave address
- (4) Execute Software Reset (ICSET) command

# Operational Notes

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

(3) Reverse connection of power supply connector

The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

(4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines. In this regard, or the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner.

Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(5) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

(7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

(9) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(10) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

(11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(12) No Connecting input terminals

In terms of extremely high impedance of CMOS gate, to open the input terminals causes unstable state. And unstable state brings the inside gate voltage of p-channel or n-channel transistor into active. As a result, battery current may increase. And unstable state can also causes unexpected operation of IC. So unless otherwise specified, input terminals not being used should be connected to the power supply or GND line.

(13) Rush current

When power is first supplied to the CMOS IC, it is possible that the internal logic may be unstable and rush current may flow instantaneously. Therefore, give special condition to power coupling capacitance, power wiring, width of GND wiring, and routing of connections.

# Ordering Information

В	U	9	7	9	6	А	х	х	Х	-	E 2	
Part N	umber					Packa FS MUV	age	: SSOF : VQFN	P-A32 1024V40		Packaging and form E2: Embossed tape (SSOP-A32/ VC	- ·

# ●Lineup

Segment output	Common output	Packa	ige	Orderable Part Number
20	Λ	SSOP-A32	Reel of 2000	BU9796AFS-E2
12	4	VQFN024V4040	Reel of 2500	BU9796AMUV-E2

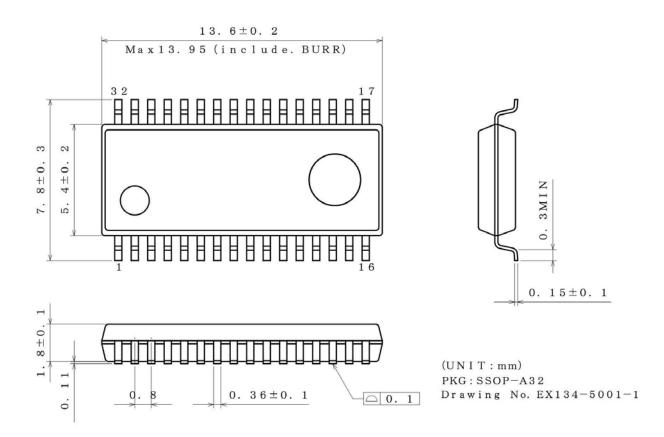
Status of this document

The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document formal version takes priority.

# Physical Dimension Tape and Reel Information

BU9796AFS(SSOP-A32)



<tape and="" r<="" th=""><th>leel information&gt;</th></tape>	leel information>
Таре	Embossed carrier tape
Quantity	2000pcs
Direction of feed	E2 ( The direction is the 1pin of product is at the upper left when you hold ( reel on the left hand and you pull out the tape on the right hand
	Reel *Order quantity needs to be multiple of the minimum quantity.